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Team Nexperia



**22 November 2016** 

**Product data sheet** 

# 1. General description

Unidirectional Transient Voltage Suppressor (TVS) in a very small leadless DSN1608-2 (SOD964) package.

#### 2. Features and benefits

- Rated peak pulse current: I<sub>PPM</sub> = 41 A (8/20 µs pulse)
- Rated peak pulse power: P<sub>PPM</sub> = 1800 W (8/20 μs pulse)
- Dynamic resistance R<sub>dvn</sub> = 0.17 Ω
- Reverse current: I<sub>RM</sub> = 0.1 nA
- · Very low package height: 0.29 mm

## 3. Applications

- Power supply protection
- Industrial application
- · Power management

## 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{RWM}$	reverse standoff voltage	T <sub>amb</sub> = 25 °C		-	-	18	V
I <sub>PPM</sub>	current	t <sub>p</sub> = 8/20 μs	[1] [2]	-	-	41	Α
		t <sub>p</sub> = 10/1000 μs	[3] [2]	-	-	6.4	Α

- [1] In accordance with IEC 61000-4-5 (8/20  $\mu s$  current waveform).
- [2] Measured from pin 1 to pin 2.
- [3] In accordance with IEC 61643-321 (10/1000 µs current waveform).



# 5. Pinning information

#### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		1 + 2
2	А	anode	1 2	sym035
			Transparent top view DSN1608-2 (SOD964)	

# 6. Ordering information

## **Table 3. Ordering information**

Type number	Package					
	Name	Description	Version			
PTVS18VZ1USK	DSN1608-2	leadless very small package; 2 terminals; body 1.6 x 0.8 x 0.29 mm	SOD964			

## 7. Marking

#### Table 4. Marking codes

Type number	Marking code
PTVS18VZ1USK	<b>Z7</b>

# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
P <sub>PPM</sub>	rated peak pulse power	t <sub>p</sub> = 8/20 μs	[1] [2]	-	1800	W
		t <sub>p</sub> = 10/1000 μs	[3] [2]	-	210	W
I <sub>PPM</sub>	rated peak pulse current	t <sub>p</sub> = 8/20 μs	[1] [2]	-	41	Α
		t <sub>p</sub> = 10/1000 μs	[3] [2]	-	6.4	Α
Tj	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-40	125	°C
T <sub>stg</sub>	storage temperature			-65	150	°C
ESD maximu	ım ratings					
$V_{ESD}$	electrostatic discharge	IEC 61000-4-2; contact discharge	[4] [2]	-	30	kV
	voltage	IEC 61000-4-2; air discharge	[4] [2]	-	30	kV

- [1] In accordance with IEC 61000-4-5 (8/20 µs current waveform).
- [2] Measured from pin 1 to pin 2.
- [3] In accordance with IEC 61643-321 (10/1000 µs current waveform).
- [4] Device stressed with ten non-repetitive ESD pulses.

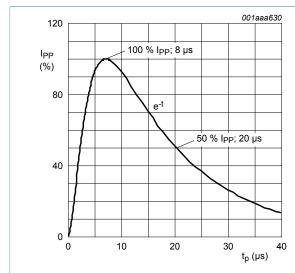


Fig. 1. 8/20 µs pulse waveform according to IEC 61000-4-5

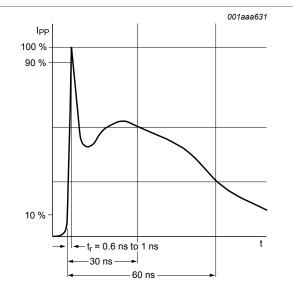
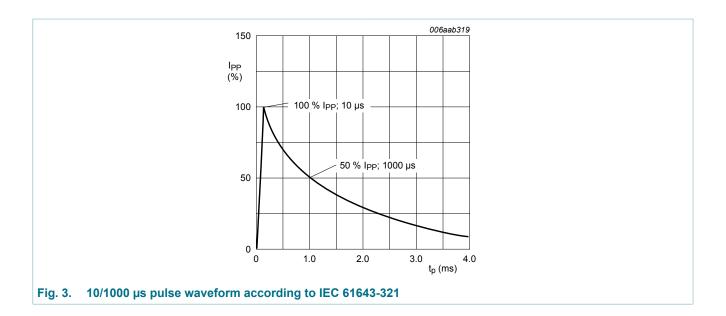


Fig. 2. ESD pulse waveform according to IEC 61000-4-2

**NXP Semiconductors** PTVS18VZ1USK

## Transient voltage suppressor in DSN1608-2 for mobile applications



## 9. Characteristics

**Table 6. Characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{RWM}$	reverse standoff voltage	T <sub>amb</sub> = 25 °C		-	-	18	V
$V_{BR}$	breakdown voltage	I <sub>R</sub> = 10 mA; T <sub>amb</sub> = 25 °C	[1]	20	21.6	23.2	V
I <sub>RM</sub>	reverse leakage current	V <sub>RWM</sub> = 18 V; T <sub>amb</sub> = 25 °C	[1]	-	0.1	200	nA
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 0 V; T <sub>amb</sub> = 25 °C		-	290	-	pF
V <sub>CL</sub>	clamping voltage	I <sub>PPM</sub> = 41 A; T <sub>amb</sub> = 25 °C; t <sub>p</sub> = 8/20 μs	[2] [1]	-	35.5	44	V
		$I_{PPM} = 6.4 \text{ A}; T_{amb} = 25 \text{ °C};$ $t_p = 10/1000  \mu\text{s}$	[3] [1]	-	27	32.8	V
R <sub>dyn</sub>	dynamic resistance	I <sub>R</sub> = 10 A; T <sub>amb</sub> = 25 °C	[4] [1]	-	0.17	-	Ω

- Measured from pin 1 to 2.
- In accordance with IEC 61000-4-5 (8/20 µs current waveform). In accordance with IEC 61643-321 (10/1000 µs current waveform). [3]
- Non-repetitive current pulse, Transmission Line Pulse (TLP)  $t_p$  = 100 ns; square pulse; ANSI / ESD STM5.5.1-2008.

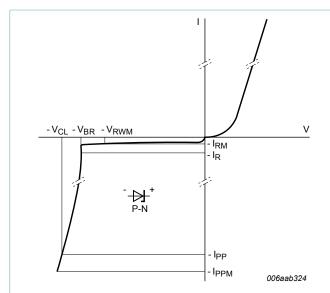


Fig. 4. V-I characteristics for a unidirectional TVS protection diode

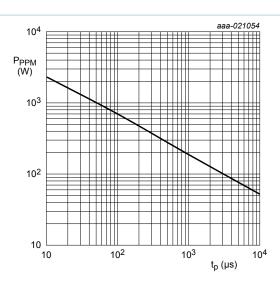


Fig. 5. Rated peak pulse power as a funtion of square pulse duration; typical values

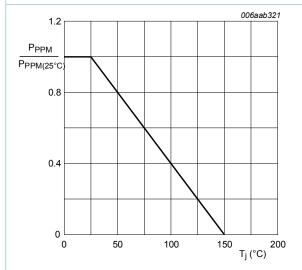
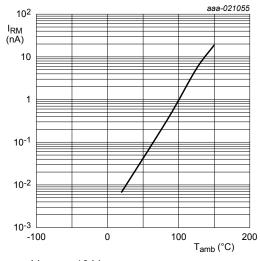


Fig. 6. Relative variation of rated peak pulse power as a function of junction temperature; typical values



 $V_{RWM}$  = 18 V

Fig. 7. Relative variation of reverse leakage current as a function of ambient temperature; typical values

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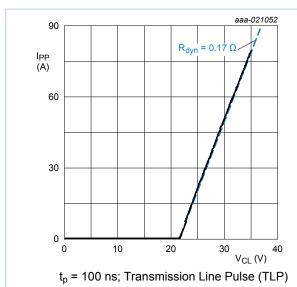


Fig. 8. Positive clamping voltage (TLP); typical values

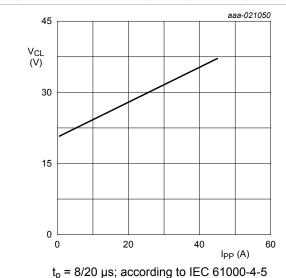
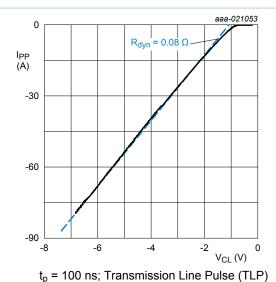


Fig. 10. Positive clamping voltage (8/20 μs pulse); typical values



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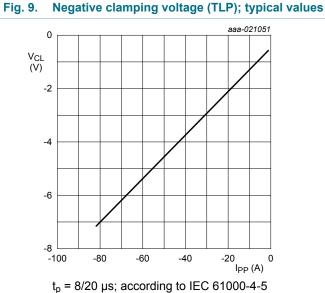
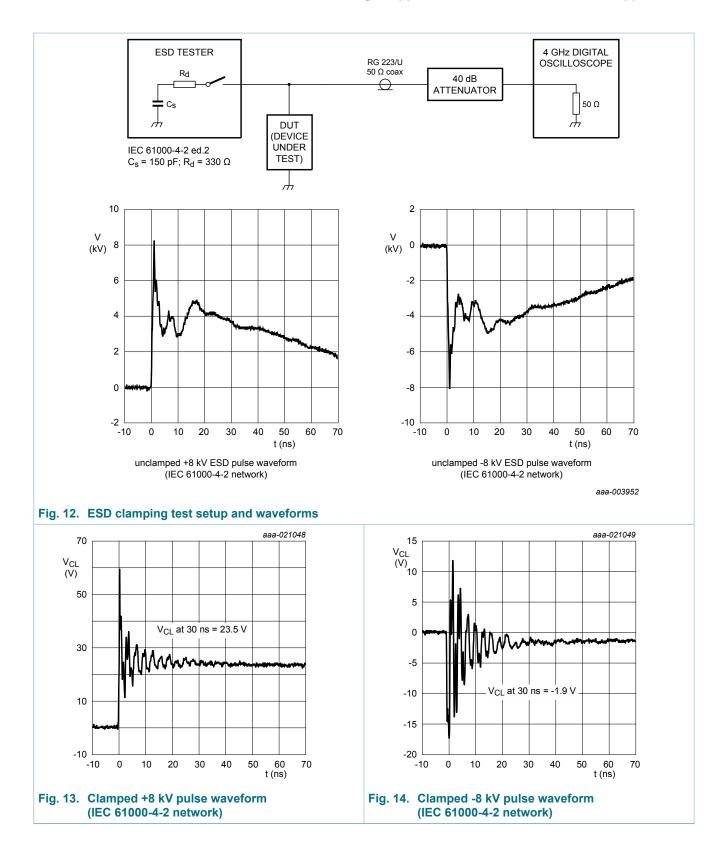
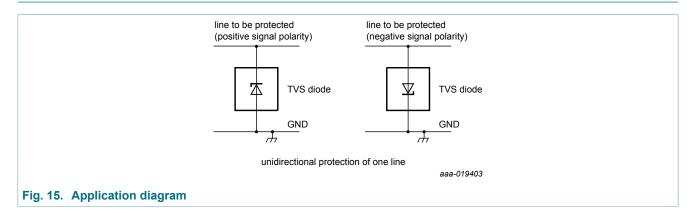


Fig. 11. Negative clamping voltage (8/20 μs pulse); typical values

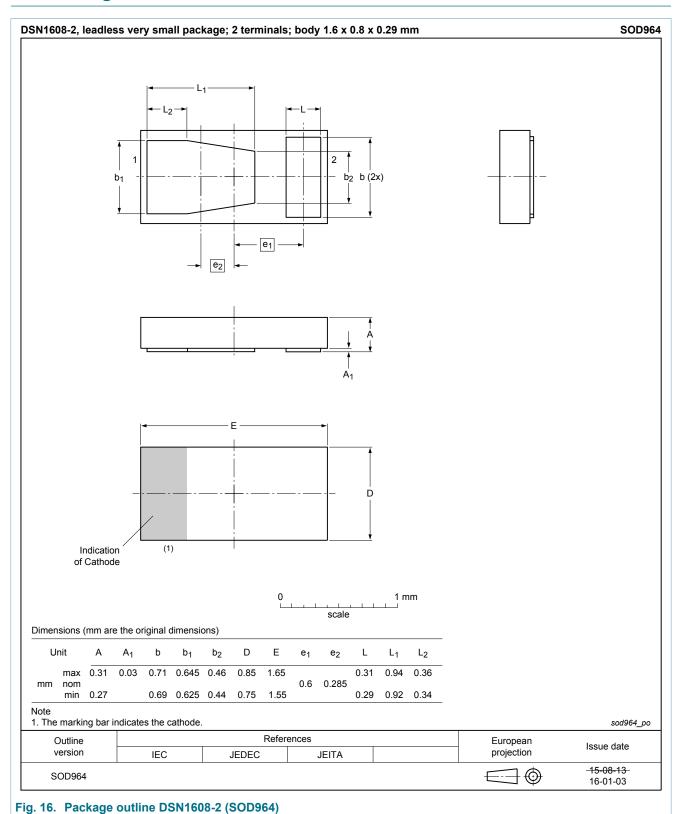


# 10. Application information



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# 11. Package outline



# 12. Soldering

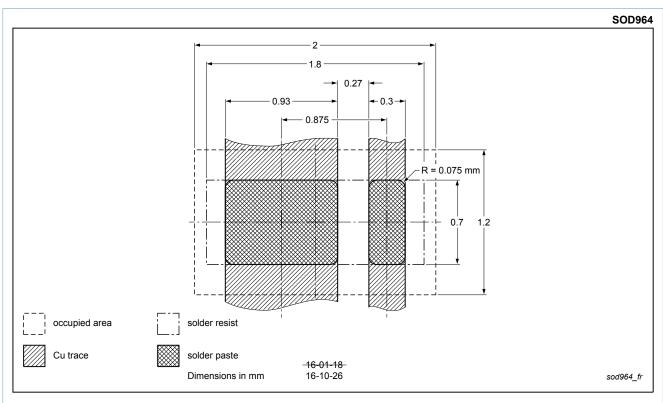


Fig. 17. Reflow soldering footprint for DSN1608-2 (SOD964)

# 13. Revision history

#### Table 7. Revision history

Data sheet ID	Release date	Data sheet status Change notice		Supersedes			
PTVS18VZ1USK v.2	20161122	Product data sheet	-	PTVS18VZ1USK v.1			
Modifications:	Updated data sheet according to the latest measurements						
PTVS18VZ1USK v.1	20160212	Preliminary data sheet	-	-			

# 14. Legal information

#### **Data sheet status**

Document status [1] [2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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PTVS18VZ1USK

#### Transient voltage suppressor in DSN1608-2 for mobile applications

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# PTVS18VZ1USK

## Transient voltage suppressor in DSN1608-2 for mobile applications

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